

MMIC

# REFLECTIONLESS FILTER DICE

50Ω DC to 21 GHz

## The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 21 GHz
- Stop band up to 35 GHz
- Excellent repeatability through IPD\* process
- Unpackaged Die Form



**X-Series**

Available in Low Pass, High Pass and Band Pass designs

## Product Overview

Mini-Circuits' X-Series reflectionless filters employ a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolators, isolation amplifiers or attenuators.

### Key Features

Easy integration with sensitive reflective components, e.g. mixers, multipliers

Enables stable integration of wideband amplifiers

Cascadable

Excellent power handling in a tiny surface mount device

Excellent repeatability of RF performance

Excellent stability over temperature

Operating Temperature up to 105°C

Unpackaged Die form

### Advantages

Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.

Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.

Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.

High power handling extends the usability of these filters to the transmit path for inter-stage filtering.

Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.

With  $\pm 0.3$  dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.

Suitable for operation close to high power components

Enables direct integration into customer hybrids

\*IPD – Integrated Passive Device, is a GaAs semiconductor process



# Reflectionless Low Pass Filter Die

## XLF-732-D+

50Ω DC to 7300 MHz

### Features

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Protected by US Patent No. 8,392,495



### Applications

- Harmonics Rejection
- Wideband Matching
- Transmitters / Receivers

#### +RoHS Compliant

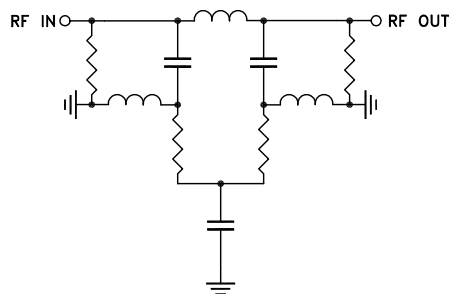
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page

### General Description

Mini-Circuits' XLF-732-D+ reflectionless filter die employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

### Simplified Schematic



Pad	Description
RF-IN	RF Input Pad
RF-OUT	RF Output Pad
Ground	Ground Bonding Pad

**Electrical Specifications<sup>1</sup> at 25°C**

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Insertion Loss	DC - F1	DC - 7300		1.1		dB
	Frequency Cut-off	F2	9800		3.0		dB
	VSWR	DC - F1	DC - 7300		1.2		:1
Stop Band	Rejection	F3 - F5	14300 - 34000		16		dB
	VSWR	F3 - F4	14300 - 25000		2.5		:1
		F4 - F5	25000 - 34000		3.0		:1

<sup>1</sup> Measured on Mini-Circuits Characterization test board. Die packaged in 3mm x 3mm, 12-lead MCLP package and soldered on TB-844-732+

**Absolute Maximum Ratings<sup>1,4</sup>**

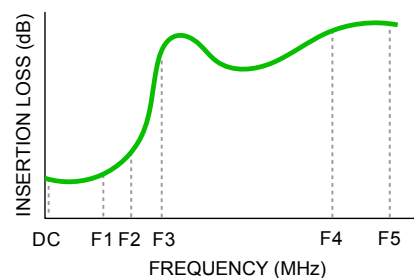
Parameter	Ratings
Operating Temperature	-55°C to +105°C
RF Power Input, Passband (DC-F1) <sup>2</sup>	2W at 25°C
RF Power Input, Stopband (F2-F5) <sup>3</sup>	0.2W at 25°C

<sup>2</sup> Passband rating derates linearly to 1W at 105°C ambient

<sup>3</sup> Stopband rating derates linearly to 0.1W at 105°C ambient

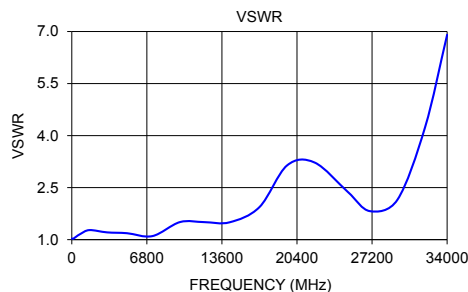
<sup>4</sup> Permanent damage may occur if any of these limits are exceeded.

**Specification Definition**



**Typical Performance Data at 25°C<sup>1</sup>**

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10	0.40	1.03
100	0.38	1.02
200	0.39	1.04
400	0.40	1.09
800	0.44	1.17
1600	0.52	1.28
3200	0.57	1.21
5000	0.69	1.19
7300	1.09	1.10
9800	2.97	1.51
12000	7.38	1.51
14300	15.66	1.50
17000	26.40	1.94
19500	22.31	3.14
22000	20.23	3.22
25000	18.17	2.38
27000	17.64	1.82
29500	17.81	2.15
32000	20.13	4.24
34000	21.50	6.90



**Die Layout**



Fig 1. Die Layout

**Bonding Pad Position**  
(Dimensions in  $\mu\text{m}$ , Typical)

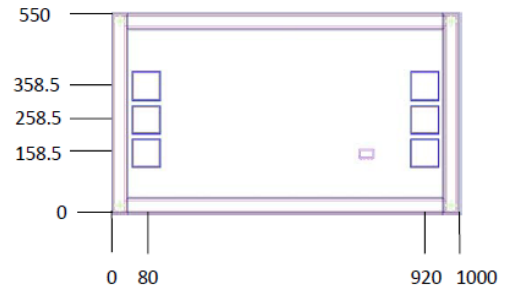


Fig 2. Bonding Pad Positions

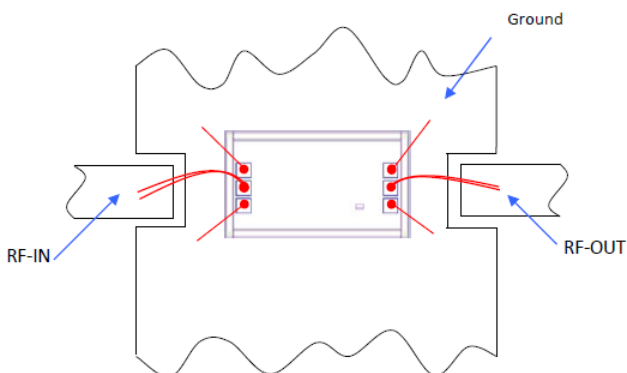
**Critical Dimensions**

Parameter	Values
Die Thickness, $\mu\text{m}$	100
Die Width, $\mu\text{m}$	1000
Die Length, $\mu\text{m}$	550
Bond Pad Size (Ground pad), $\mu\text{m}$	75 x 75

## Assembly and Handling Procedure

1. Storage  
Dice should be stored in a dry nitrogen purged desiccators or equivalent.
2. ESD  
MMIC Gallium Arsenide (GaAs) filter dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.
3. Die Attach  
The die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030Hk-PT/H579/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic die pick up tools only.
4. Wire Bonding  
Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.

## Assembly Diagram



### Recommended Wire Length, Typical

Wire	Wire Length (mm)	Wire Loop Height (mm)
All wires	1.0	0.15

Note: Use double bond wire at RF IN & RF OUT

Additional Detailed Technical Information							
<i>additional information is available on our dash board.</i>							
Performance Data	Data Table						
	Swept Graphs						
	S-Parameter (S2P Files) Data Set with and without port extension(.zip file)						
Case Style	Die						
Die Ordering and packaging information	<table> <tr> <td>Quantity, Package</td> <td>Model No.</td> </tr> <tr> <td>Small, Gel - Pak: 10,50,100 KGD*</td> <td>XLF-732-DG+</td> </tr> <tr> <td>Medium†, Partial wafer: KGD*&lt;5K</td> <td>XLF-732-DP+</td> </tr> </table>	Quantity, Package	Model No.	Small, Gel - Pak: 10,50,100 KGD*	XLF-732-DG+	Medium†, Partial wafer: KGD*<5K	XLF-732-DP+
	Quantity, Package	Model No.					
Small, Gel - Pak: 10,50,100 KGD*	XLF-732-DG+						
Medium†, Partial wafer: KGD*<5K	XLF-732-DP+						
	†Available upon request contact sales representative  Refer to <a href="#">AN-60-067</a>						
Environmental Ratings	ENV-80						

\*Known Good Dice ("KGD") means that the dice are taken from PCM good wafer and visually inspected according to Mini-Circuits inspection criteria. While this is not definitive, it does help to provide a higher degree of confidence that dice are capable of meeting typical RF electrical parameters specified by Mini-Circuits.

## ESD Rating\*\*

Human Body Model (HBM): Class 1A (250V) in accordance with ANSI/ESD STM 5.1 - 2001

\*\* Tested in industry standard MCLP 3x3mm 12 lead package.

### Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
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Typical Performance Data

FREQ.  (MHz)	INSERTION LOSS					GROUP DELAY				
	(dB)					(nsec)				
	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C
10	0.38	0.36	0.40	0.43	0.45	0.12	0.13	0.13	0.13	0.15
50	0.34	0.35	0.38	0.40	0.43	0.08	0.09	0.09	0.09	0.10
100	0.34	0.35	0.39	0.41	0.43	0.05	0.06	0.05	0.06	0.06
200	0.34	0.36	0.40	0.43	0.44	0.05	0.05	0.05	0.05	0.05
300	0.35	0.36	0.40	0.44	0.46	0.05	0.05	0.05	0.05	0.05
400	0.34	0.36	0.41	0.45	0.46	0.05	0.05	0.05	0.05	0.05
500	0.35	0.37	0.42	0.46	0.48	0.05	0.05	0.04	0.05	0.05
600	0.35	0.37	0.43	0.48	0.50	0.05	0.05	0.05	0.05	0.05
700	0.35	0.37	0.44	0.49	0.51	0.05	0.05	0.04	0.05	0.05
800	0.36	0.37	0.44	0.49	0.51	0.05	0.05	0.05	0.05	0.05
900	0.37	0.38	0.45	0.50	0.53	0.05	0.05	0.04	0.05	0.05
1000	0.37	0.39	0.46	0.52	0.53	0.05	0.05	0.05	0.05	0.05
1200	0.39	0.41	0.48	0.55	0.56	0.05	0.05	0.04	0.05	0.05
1400	0.40	0.43	0.51	0.57	0.59	0.05	0.05	0.05	0.05	0.05
1600	0.43	0.45	0.52	0.59	0.61	0.05	0.05	0.04	0.05	0.05
1800	0.44	0.46	0.54	0.60	0.62	0.04	0.05	0.04	0.05	0.05
2000	0.44	0.47	0.55	0.61	0.63	0.05	0.05	0.04	0.05	0.05
2500	0.45	0.48	0.57	0.64	0.66	0.05	0.05	0.04	0.05	0.05
3000	0.45	0.48	0.58	0.65	0.68	0.05	0.05	0.04	0.05	0.05
3500	0.46	0.49	0.60	0.68	0.71	0.05	0.05	0.05	0.05	0.05
4000	0.48	0.52	0.63	0.73	0.76	0.05	0.05	0.05	0.05	0.05
4500	0.51	0.55	0.68	0.78	0.82	0.05	0.05	0.05	0.05	0.05
5000	0.56	0.59	0.73	0.84	0.88	0.05	0.05	0.05	0.05	0.05
5500	0.59	0.63	0.78	0.89	0.94	0.05	0.05	0.05	0.05	0.05
6000	0.64	0.68	0.85	0.97	1.02	0.05	0.05	0.05	0.05	0.05
6500	0.69	0.74	0.92	1.05	1.10	0.06	0.05	0.05	0.06	0.06
7000	0.78	0.84	1.02	1.18	1.23	0.06	0.06	0.05	0.06	0.06
7300	0.85	0.90	1.11	1.27	1.32	0.06	0.06	0.05	0.06	0.06
7500	0.91	0.96	1.17	1.33	1.40	0.06	0.06	0.06	0.06	0.06
7800	1.01	1.07	1.29	1.47	1.53	0.06	0.06	0.06	0.06	0.06
8000	1.08	1.15	1.38	1.56	1.63	0.06	0.06	0.06	0.06	0.06
8200	1.18	1.24	1.48	1.68	1.75	0.06	0.06	0.06	0.06	0.06
8400	1.29	1.35	1.60	1.80	1.88	0.06	0.06	0.06	0.06	0.06
8600	1.42	1.49	1.74	1.95	2.03	0.06	0.06	0.06	0.06	0.06
8800	1.56	1.64	1.89	2.11	2.19	0.06	0.07	0.06	0.06	0.07
9000	1.73	1.80	2.07	2.29	2.37	0.06	0.07	0.06	0.06	0.07
9200	1.91	1.98	2.27	2.49	2.58	0.06	0.06	0.06	0.06	0.07
9400	2.10	2.18	2.48	2.72	2.79	0.07	0.07	0.06	0.07	0.07
9600	2.31	2.39	2.71	2.95	3.03	0.07	0.07	0.06	0.06	0.07
9800	2.54	2.63	2.96	3.22	3.30	0.07	0.07	0.07	0.07	0.07
10000	2.79	2.89	3.24	3.50	3.59	0.07	0.07	0.06	0.07	0.07
10200	3.07	3.17	3.52	3.81	3.89	0.07	0.07	0.06	0.07	0.07
10400	3.37	3.47	3.84	4.13	4.23	0.07	0.07	0.06	0.07	0.07
10600	3.70	3.79	4.17	4.48	4.58	0.07	0.07	0.06	0.07	0.07
10800	4.04	4.14	4.54	4.86	4.96	0.07	0.07	0.06	0.07	0.07
11000	4.42	4.53	4.92	5.26	5.37	0.07	0.07	0.06	0.06	0.07
12000	6.78	6.91	7.34	7.73	7.86	0.06	0.06	0.06	0.06	0.06
13000	9.92	10.03	10.46	10.88	11.02	0.05	0.05	0.05	0.05	0.05
14000	13.67	13.80	14.31	14.74	14.87	0.04	0.04	0.04	0.04	0.04
14300	14.97	15.12	15.64	16.07	16.23	0.03	0.04	0.03	0.03	0.03
15000	18.46	18.60	19.18	19.62	19.76	0.02	0.01	0.01	0.00	0.00
16000	24.49	24.60	24.85	25.02	25.03	-0.06	-0.07	-0.08	-0.08	-0.08
17000	26.89	26.87	26.40	26.02	25.89	-0.10	-0.10	-0.08	-0.07	-0.06
18000	24.17	24.15	24.04	23.87	23.82	0.01	-0.01	-0.01	0.00	0.00
19000	22.45	22.51	22.53	22.50	22.55	0.02	0.02	0.01	0.02	0.01
20000	21.57	21.66	21.63	21.74	21.79	0.01	0.02	0.02	0.01	0.02
21000	20.89	20.97	21.17	21.22	21.24	0.03	0.02	0.00	0.01	0.01
22000	19.90	19.99	20.10	20.14	20.12	0.03	0.02	0.02	0.03	0.02
23000	19.04	19.10	19.25	19.31	19.28	0.04	0.03	0.03	0.03	0.03
24000	18.35	18.39	18.53	18.65	18.67	0.03	0.03	0.03	0.03	0.04
25000	17.70	17.77	18.04	18.19	18.25	0.04	0.04	0.03	0.03	0.04
26000	17.09	17.21	17.59	17.86	17.96	0.04	0.05	0.04	0.04	0.04
27000	16.74	16.81	17.32	17.70	17.81	0.06	0.05	0.05	0.03	0.05
28000	16.63	16.76	17.23	17.59	17.72	0.04	0.04	0.05	0.04	0.05
29000	16.85	17.03	17.42	17.82	17.97	0.05	0.05	0.05	0.05	0.05
30000	17.29	17.46	18.02	18.34	18.39	0.05	0.04	0.04	0.04	0.04
31000	18.07	18.25	18.85	19.05	19.11	0.04	0.04	0.02	0.04	0.03
32000	19.14	19.32	19.60	19.92	20.02	0.03	0.03	0.03	0.04	0.04
33000	20.21	20.26	20.41	20.99	21.12	0.03	0.03	0.02	0.03	0.03
34000	21.16	21.26	21.30	21.62	21.89	-0.02	-0.01	0.00	0.01	0.00
35000	20.82	20.93	21.10	21.52	21.69	0.03	0.04	0.04	0.01	0.02
36000	20.85	20.81	20.94	21.13	21.00	0.00	0.01	0.03	0.00	0.03
37000	19.12	19.10	19.17	19.28	19.22	0.02	0.03	0.00	0.02	0.02
38000	17.01	17.03	16.89	16.73	16.69	0.02	0.03	0.02	0.04	0.05
39000	13.16	13.18	13.37	13.29	13.25	0.08	0.08	0.09	0.09	0.10
40000	10.44	10.55	11.03	11.43	11.63	0.10	0.15	0.10	0.10	0.12



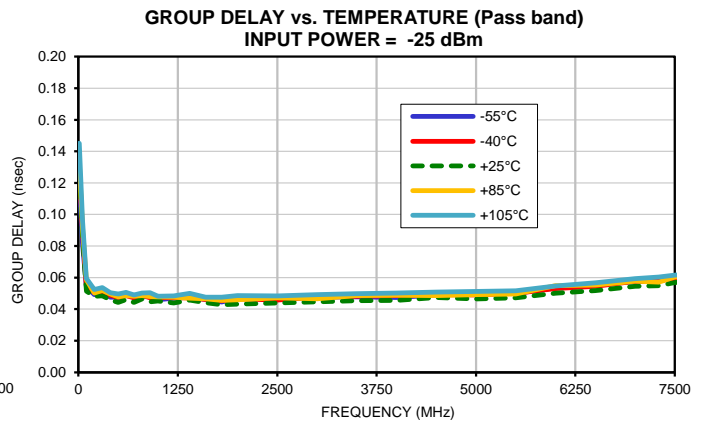
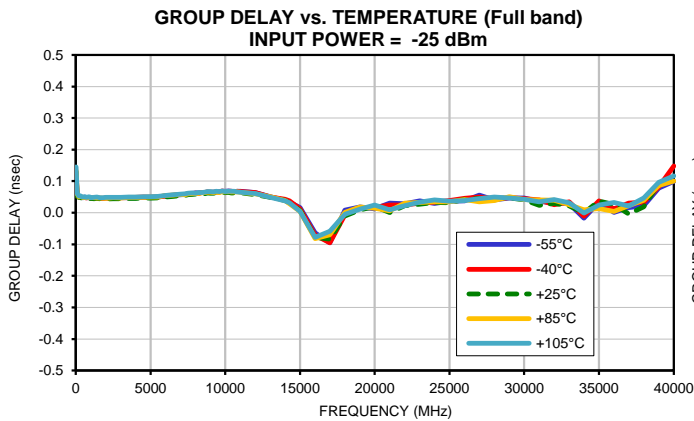
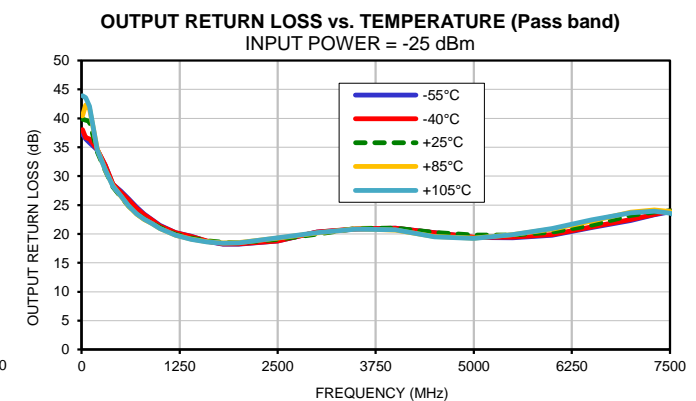
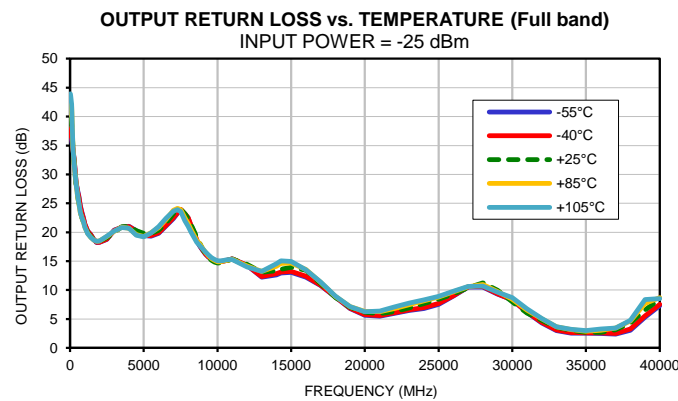
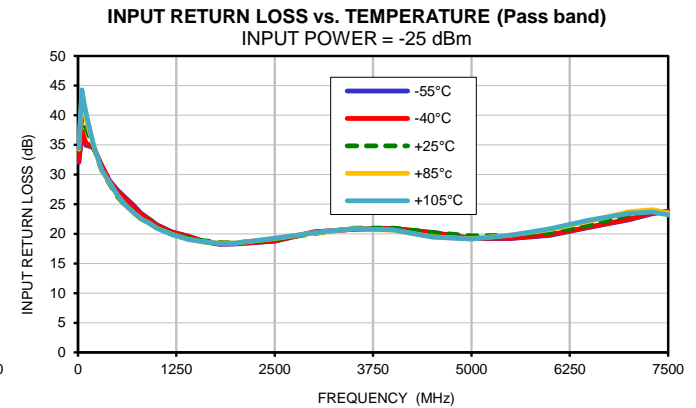
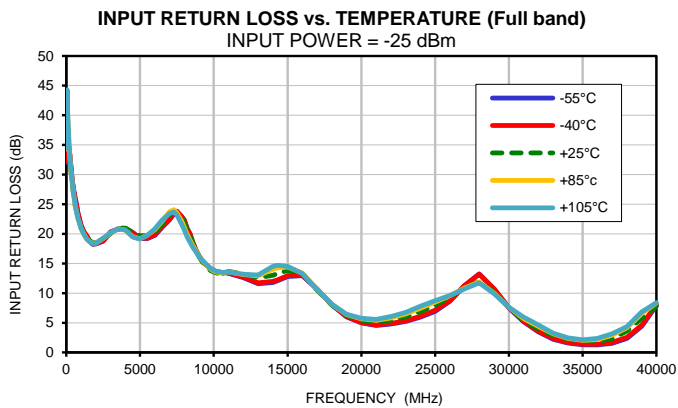
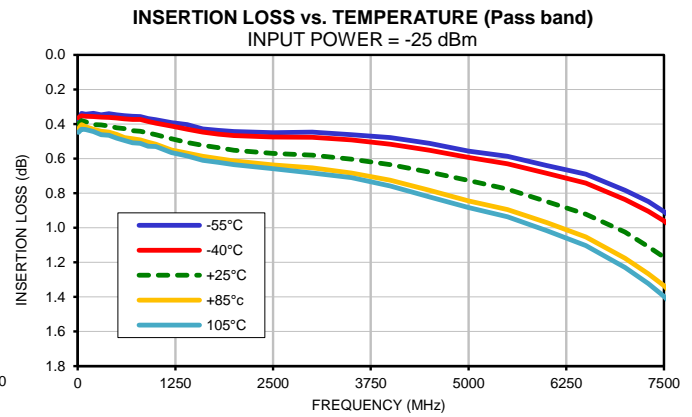
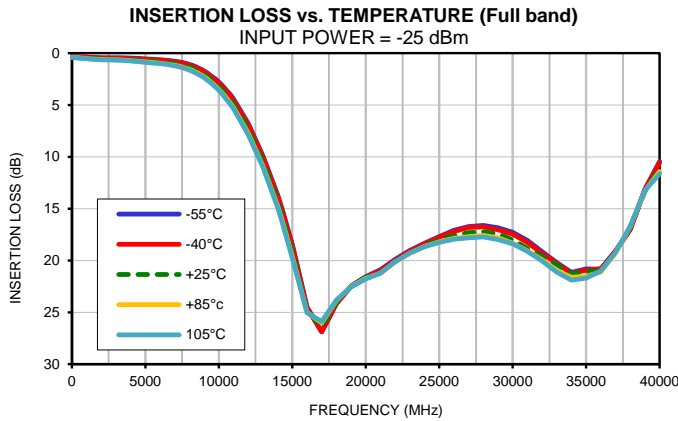
Typical Performance Data

FREQ.  (MHz)	INPUT RETURN LOSS					OUTPUT RETURN LOSS				
	(dB)					(dB)				
	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C	@-55°C	@-40°C	@+25°C	@+85°C	@+105°C
10	32.04	32.18	34.66	34.28	34.44	37.29	38.03	39.87	40.40	43.91
50	36.77	37.38	39.50	43.25	44.30	36.43	36.67	39.70	42.32	43.60
100	34.97	35.32	37.93	39.48	40.50	35.79	36.45	39.47	41.71	42.09
200	34.56	34.46	34.57	34.90	34.88	34.54	34.58	34.15	34.70	34.57
300	31.46	31.55	30.73	30.64	30.78	31.89	31.91	31.04	31.13	31.14
400	28.97	28.95	28.42	28.63	28.74	28.58	28.62	28.14	28.35	28.27
500	27.43	27.25	26.31	26.55	26.57	27.41	27.19	26.42	26.55	26.59
600	26.11	25.91	24.77	24.82	24.88	26.10	25.90	24.78	24.80	24.87
700	24.88	24.65	23.71	23.64	23.68	24.65	24.44	23.54	23.43	23.47
800	23.49	23.30	22.55	22.51	22.51	23.45	23.29	22.57	22.49	22.52
900	22.53	22.46	21.91	21.81	21.84	22.44	22.37	21.86	21.78	21.78
1000	21.53	21.45	21.12	20.94	20.95	21.47	21.39	21.09	20.92	20.92
1200	20.30	20.28	20.04	19.87	19.83	20.21	20.21	19.93	19.79	19.75
1400	19.60	19.58	19.25	19.06	19.04	19.59	19.56	19.28	19.09	19.08
1600	18.70	18.73	18.81	18.64	18.62	18.75	18.76	18.83	18.66	18.62
1800	18.23	18.29	18.55	18.42	18.37	18.21	18.26	18.55	18.42	18.41
2000	18.28	18.32	18.49	18.46	18.45	18.24	18.28	18.47	18.50	18.47
2500	18.76	18.80	19.09	19.22	19.26	18.75	18.79	19.06	19.27	19.30
3000	20.34	20.29	20.01	20.12	20.16	20.34	20.30	19.97	20.14	20.19
3500	20.76	20.76	20.96	20.85	20.87	20.81	20.86	20.96	20.85	20.82
4000	20.90	20.89	20.96	20.63	20.65	21.00	20.96	21.02	20.67	20.69
4500	20.21	20.17	20.23	19.51	19.44	20.24	20.21	20.26	19.57	19.50
5000	19.21	19.25	19.65	19.14	19.09	19.41	19.44	19.83	19.28	19.20
5500	19.19	19.26	19.73	19.81	19.75	19.33	19.43	19.82	19.89	19.87
6000	19.76	19.86	20.25	20.73	20.84	19.79	19.90	20.28	20.80	20.95
6500	21.08	21.16	21.47	22.13	22.34	21.09	21.20	21.53	22.19	22.42
7000	22.35	22.49	23.21	23.71	23.45	22.35	22.49	23.18	23.78	23.65
7300	23.40	23.48	23.77	24.05	23.68	23.31	23.37	23.77	24.13	23.91
7500	23.79	23.83	23.64	23.56	23.18	23.83	23.95	23.98	23.89	23.57
7800	22.96	22.96	22.80	22.20	21.70	23.13	23.20	23.14	22.44	21.98
8000	22.30	22.31	21.89	21.13	20.67	22.47	22.50	22.37	21.51	21.02
8200	20.86	20.88	20.71	19.91	19.47	21.10	21.17	21.34	20.46	20.04
8400	19.92	19.97	19.63	18.94	18.59	20.03	20.12	20.25	19.56	19.15
8600	18.26	18.37	18.34	17.92	17.63	18.55	18.67	19.06	18.60	18.25
8800	17.12	17.23	17.26	17.09	16.92	17.54	17.64	18.05	17.65	17.65
9000	16.20	16.28	16.21	16.26	16.22	16.79	16.88	17.07	17.16	17.08
9200	15.50	15.53	15.35	15.56	15.62	16.13	16.20	16.23	16.50	16.55
9400	14.90	14.92	14.69	14.96	15.08	15.67	15.69	15.59	15.90	16.03
9600	14.53	14.54	14.20	14.46	14.56	15.37	15.37	15.13	15.44	15.57
9800	14.12	14.11	13.79	14.01	14.13	15.14	15.13	14.82	15.10	15.27
10000	13.82	13.81	13.55	13.73	13.88	14.95	14.93	14.69	14.90	15.04
10200	13.61	13.60	13.39	13.53	13.65	14.94	14.92	14.68	14.86	15.03
10400	13.51	13.51	13.39	13.48	13.59	14.98	14.98	14.81	14.98	15.12
10600	13.39	13.39	13.43	13.42	13.48	15.12	15.08	14.98	15.09	15.19
10800	13.45	13.46	13.57	13.51	13.52	15.27	15.28	15.17	15.21	15.25
11000	13.33	13.37	13.65	13.56	13.53	15.37	15.36	15.35	15.30	15.28
12000	12.58	12.69	13.18	13.16	13.18	14.27	14.29	14.43	14.14	13.99
13000	11.58	11.71	12.60	12.89	13.06	12.23	12.36	13.09	13.24	13.22
14000	11.78	11.98	13.02	14.00	14.48	12.63	12.81	13.32	14.13	14.56
14300	12.05	12.24	13.30	14.27	14.69	12.93	13.09	13.58	14.58	15.06
15000	12.81	12.96	13.80	14.38	14.52	13.04	13.21	13.91	14.68	14.93
16000	12.94	13.05	13.19	13.37	13.30	12.25	12.41	13.41	13.54	13.47
17000	10.64	10.71	10.51	10.65	10.64	10.76	10.85	11.10	11.31	11.38
18000	8.03	8.09	7.98	8.12	8.16	8.80	8.82	8.70	8.90	8.98
19000	5.98	6.06	6.26	6.39	6.44	6.78	6.85	7.01	7.11	7.11
20000	4.96	5.05	5.39	5.65	5.74	5.64	5.74	6.14	6.29	6.27
21000	4.54	4.64	5.03	5.39	5.57	5.47	5.56	5.93	6.24	6.34
22000	4.76	4.87	5.43	5.82	6.04	5.99	6.07	6.25	6.80	7.05
23000	5.21	5.34	6.02	6.47	6.74	6.45	6.56	6.90	7.48	7.74
24000	5.95	6.08	6.89	7.48	7.79	6.82	6.97	7.67	8.12	8.28
25000	6.94	7.09	7.93	8.47	8.71	7.55	7.69	8.39	8.78	8.92
26000	8.64	8.73	9.32	9.56	9.58	8.94	9.01	9.28	9.65	9.81
27000	11.24	11.28	10.96	10.86	10.70	10.52	10.58	10.40	10.57	10.62
28000	13.24	13.20	11.94	11.88	11.71	10.51	10.64	11.23	11.93	10.66
29000	10.67	10.69	10.16	10.00	9.87	9.27	9.35	9.96	9.74	9.61
30000	7.51	7.54	7.53	7.58	7.61	8.29	8.28	7.97	8.42	8.69
31000	5.17	5.26	5.35	5.72	5.95	6.15	6.18	6.02	6.53	6.75
32000	3.46	3.56	3.96	4.39	4.62	4.34	4.43	4.79	5.04	5.07
33000	2.21	2.34	2.90	3.13	3.23	2.98	3.09	3.59	3.66	3.63
34000	1.58	1.68	2.22	2.38	2.45	2.56	2.65	3.02	3.17	3.23
35000	1.26	1.36	1.88	2.03	2.11	2.55	2.59	2.68	2.89	3.01
36000	1.26	1.36	1.83	2.17	2.37	2.50	2.59	2.67	3.06	3.25
37000	1.54	1.68	2.32	2.88	3.11	2.35	2.50	3.13	3.40	3.44
38000	2.35	2.55	3.63	4.15	4.34	3.04	3.23	4.26	4.62	4.73
39000	4.39	4.60	5.74	6.52	6.81	5.33	5.55	6.54	7.67	8.36
40000	7.88	8.11	7.79	8.33	8.37	7.29	7.53	8.39	8.67	8.51





## Typical Performance Curves



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment	Refer to Individual Model Data Sheet
Storage Environment (Die)	-65° to 150°C	Individual Model Data Sheet
Storage Environment(Packaging)	-40° to 70°C and 40 to 60% humidity (In Factory Shipped Package)	